## 佐賀大学大学院理工学研究科 AI・データサイエンス高度人材育成プログラム 博士後期課程(外国人留学生-在日) 学生募集要項

## Guide for the Application for the Foreign Students of Education Program for AI and Data Science Specialists (EPAD)

(Doctor Course)

## October, 2022 April, 2023

	Enrollment	Application Deadline	Examinations and Interview	l Final Results	
First application	October, 2022 or April, 2023	June 15, 2022	July 8, 2022	July 19, 2022	
Second application	October, 2022 or April, 2023	July 28, 2022	August 25, 2022	September 13, 2022	
Third application	April, 2023	November 2, 2022	November 18, 2022	December 13, 2022	
Fourth application	April, 2023	January 24, 2023	February 28, 2023	March 8, 2023	

\*This exam schedule is scheduled as of April 22. Depending on the future spread of coronavirus (COVID-19) infection, the entrance examination schedule may be postponed. If the test cannot be conducted at Saga University due to the spread of the novel coronavirus (COVID-19), the test will be postponed and/or conducted via the Internet.

Graduate School of Science and Engineering SAGA UNIVERSITY

#### Personal Information Use

In accordance with enforcement of the Act on the Protection of Personal Information Held by Independent Administrative Agencies, personal information written on the application form submitted by applicants is utilized for educational purpose (including exemption of entrance and tuition fees, payment extension of entrance fee, and scholarship) as well as the selection of applicants by entrance examinations (including additional business such as statistical transaction).

Personal information possessed by Saga University is not utilized for different purposes from the aim denoted above, and is not provided to a third person without the applicant's agreement, except for the case prescribed by the item no.9 of the Act on the Protection of Personal Information Held by Independent Administrative Agencies.

## **Education Program for AI and Data Science Specialists (EPAD)**

(Doctor Course)

October, 2022 April, 2023

(	CONTENTS
0	GUIDE FOR APPLICATION 1
0	ACADEMIC STAFFS ATTENDING EPAD COURSES AND THEIR RESEARCH INTERESTS AND MAJOR FIELDS 4
0	APPLICATION FORM (Enclosed Booklet)

## GUIDE FOR THE APPLICATION FOR THE FOREIGN STUDENTS OF

### EDUCATION PROGRAM FOR AI AND DATA SCIENCE SPECIALISTS (EPAD)

The Education program for AI and Data Science Specialists (EPAD) provides all lectures, seminars, and internships, etc. on AI and data science technologies in English for both foreign and Japanese students. Students from overseas can learn and study completely in Japan without a hurdle of Japanese language. The EPAD is an educational course in the Graduate School of Science and Engineering, Saga University, that will start in October 2022, in order to bring up global researchers and engineers who will contribute to technological innovation in AI and data science fields. This is a call for application to a three-year Doctor Course from the academic year of October, 2022 and April, 2023.

The wisdom that mankind has created by the academic deepening has brought humanity a prosperous life through developing science and technology. To improve science and technology, it is necessary to sustain efforts from the viewpoint of AI and data science technologies. Educational study of AI and data science should be performed from the all-round and global viewpoint. The EPAD has been established in the Graduate School of Science and Engineering in order to discuss and solve AI and data science problems. The scope and goal of this EPAD is the education for students to possess an all-round insight for AI and data science from the global point of view after their completion by acquiring knowledge and thinking power.

In the Doctor Course program of the EPAD, education and research guidance of the fields are given by the Mathematical and Information Science Course, Mechanical and Electrical Energy Engineering Course, Biological and Material Engineering Course in the Graduate School of Science and Engineering. Applicants are encouraged to decide the research fields and prospective relevant supervisor(s) appearing on the List of Academic Staffs, and contact with the supervisor(s).

Students who complete the Doctor Course program of the EPAD are granted the Doctor's Degree (Doctor of Philosophy in Science or Doctor of Philosophy in Engineering). The month of entrance for foreign students is October, 2022 or April 2023 and they can enter the EPAD course immediately after completing their Master's Degree program without learning Japanese language.

#### **OUALIFICATIONS**

- \* For applicants who wish to enroll in April 2023, please replace "September 2022" with "March 2023".
- 1. **Nationality:** Non-Japanese citizens staying in Japan can apply for this program.
- 2. Academic carrier: The following candidates may apply for admission.
  - a. Those who have received Master's Degree from Japanese University as of September 2022.
  - b. Those who have received a Degree equivalent to Master's Degree of Japanese Universities in foreign country, or will receive it in foreign country as of September 2022.
  - c. Those who have received a Degree equivalent to Master's Degree of Japanese Universities from a foreign school through correspondence education in Japan, or will receive the Degree as of September 2022.
  - d. Those who have received a Degree equivalent to Master's Degree of Japanese Universities at educational institutions of the foreign country in Japan, which is designated by the Minister of Education, Culture, Sports, Science and Technology of the Japanese Government, or will receive the Degree as of September 2022.
  - e. Those who have been designated by the Minister of Education, Culture, Sports, Science and Technology of the Japanese Government.
  - f. Those who are 24 years old or more as of September 2022, and are admitted by the Graduate School of Saga University as that their academic abilities are equivalent to or higher than Master's Degree of Japanese Universities upon reviewing the submitted materials.
    - \* Those who intend to apply based on the terms e or f should submit the application form to the Entrance Examination Office of Saga University one month earlier than the application deadline.
- 3. Language proficiency: A good working level of English is required.

#### **TUITION EXPENSES**

1. Entrance examination fee: 30,000 yen.

(N.B. The entrance examination fee is not necessary for the applicant who will graduate the Master Course from this University in September, 2022.)

2. **Entrance fee:** 282,000 yen.

3. **Tuition fee:** 267,900 Yen for each semester (scheduled). [535,800 Yen per academic year (scheduled).] Amount of due might be slightly revised depending on the decision of the administration council.

Payments must be done for each semester biannually within the beginning two months of the semester.

For the information on the tuition assistance, exemption subsidization, and scholarships is available at the Benefits section in the following pages.

#### **SELECTION**

- 1. Selection for admission shall be achieved by written and/or oral examinations on the selected major subjects and interview. All examinations and interview will be conducted in English on the date indicated on the cover page. This exam schedule is scheduled as of April 22. Depending on the future spread of coronavirus (COVID-19) infection, the entrance examination schedule may be postponed. If the test cannot be conducted at Saga University due to the spread of the novel coronavirus (COVID-19), the test will be postponed and/or conducted via the Internet. In this case, the detail of entrance examination will be noticed to the applicant by e-mail and examination ticket.
- 2. The final results of selection will be noticed to the applicant by a letter. It will be dispatched on **the date** indicated on the cover page.
- 3. A few students can be admitted.

#### **ADMISSION**

- 1. Date of enrollment is October 1, 2022 or April 1, 2023.
- 1. Date of registration for admission: {First and Second application } Late September, 2022

{Third and Fourth application} Late March, 2023

Details will be provided when you receive your acceptance letter. If the applicant does not register on these days, his/her admission shall be canceled.

2. Admission shall be canceled if the applicant fails to receive the Master's Degree on or before September 2022 or March, 2023.

#### APPLICATION

- \* For applicants who wish to enroll in April 2023, please replace "September 2022" with "March 2023".
- 1. Applicants should prepare the following documents to be forwarded to the Entrance Examination Office, Saga University.
  - ① **Application Form** (Form A).
  - ② Official transcript of **Master's degree** or certificate representing that the applicant will be conferred Master's degree by September 2022. Official transcript of Bachelor's degree is required in the case that the applicant will be qualified by the criterion 2-e of **QUALIFICATIONS** described above. The transcript or certificate must be sealed by the authority or sent directly from the college. Original diploma is also acceptable; in this case the examination office may exemplify the diploma and the original may be returned at the office.
  - ③ Transcripts of **Academic Record** issued by university authorities and its English translation. (The criteria of academic assessment should be also shown.)
  - 4 English summary of **Master Thesis** or it's equivalent if available, not exceeding four sheets of A4 size paper typed in double space. If a Master Thesis is not required by the University from which the applicant graduated, prepare a statement to this matter.
  - ⑤ Certificate of **Citizenship** issued by appropriate authorities.
  - 6 Recommendation and Reference

- a. A letter of **Recommendation** (Form B) from the head (Dean, in case of University) of the applicant's affiliated institution.
- b. Letter(s) of **Reference** (Form C) from those who know the applicant's research/study capability addressed to the President of Saga University.

The letters of recommendation and reference should indicate the English proficiency of the applicant. Enclose, therein, a certificate indicating the scores of TOEFL or a corresponding English Ability Test, if any.

- $\bigcirc$  Three **Photographs** (hatless portrait), 4.5 cm  $\times$  3.5 cm in size, taken within six months before the date of application. Two copies should be attached to the application form. One extra copy should be enclosed therein, with the applicant's name and nationality on the reverse side of the copies.
- **8** Entrance Examination Fee: 30,000 yen.
- 2. All documents should be sent by registered mail and received by the Entrance Examination Office by the deadline indicated on the cover page.

#### Remarks

- 1. The above documents should be type-written in English on A4 size paper.
- 2. Incomplete documents are not acceptable.
- 3. None of the documents submitted is returned to the applicant.

### **NOTES**

- 1. The applicant will be deprived his/her entrance under the following cases:
  - a. False statements on the documents.
  - b. Violation of the pledge.
- 2. Applicants are recommended to be well acquainted with the Japanese language, culture, customs, etc. A knowledge of the Japanese language is necessary in daily life.
- 3. Applicants are expected to complete their Doctor Course Program within three years.

#### BENEFITS

- 1. Exemption of tuition fee from complete to 50% may be granted depending on circumstances.
- 2. There are several scholarships for private-expense foreign students. Students can apply for these scholarships.
- 3. Housing: Students can apply to Saga University International House, or low-cost apartments supported by Saga prefecture and other organizations.

#### CORRESPONDENCE

Any correspondence relating to the application for the EPAD should be sent by mail to the address below.

Entrance Examination Office Saga University 1 Honjo-machi Saga 840-8502, Japan

E-mail: epad@mail.admin.saga-u.ac.jp

# ACADEMIC STAFFS ATTENDING EPAD COURSES AND THEIR RESEARCH INTERESTS AND MAJOR FIELDS

## **Graduate School of Science and Engineering [Doctor course]**

## Mathematical and Information Science Course

Data Science	
Data S	Science Minamoto, T.
	Numerical Verification, Image Processing, Signal Processing, Digital Watermark
	Wavelet Analysis, Applied Mathematics, Data Science, Numerical Analysis,
	Mathematical Programming
Computer	Science and Information Engineering
Smart	SystemMatsumae, S., Nakayama, K.
	Intelligent Informatics, Artificial Intelligence,
	Parallel and Distributed Algorithms
Cyber	Physical SystemFukuda, O., Okumura, H.
	Artificial intelligence, Robotics, Intelligent sensing,
	Data science, Data visualization, Biological system,
	Remote sensing, Medical image processing
Funda	amental and Advanced InformaticsHanada, E., Hori, Y., Okazaki, Y.
-	Information/Comminication Systems in Clinical medicine/Healthcare/Welfare,
nical and	Hospital Facilities, Information and Systems in Education, Computational Science  **Electrical Energy Engineering Course**  **LECTRON For the Property of the
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nical and Thermo-Flu Therm	**Electrical Energy Engineering Course  uid Energy Engineering  nal Engineering  Miyara, A., Mitsutake, Y.  Kariya, K. and Ishida, K.  Thermodynamics, energy conversion, power plant systems  Heat exchanger, condensation, evaporation, absorption  Engineering  Kinoue, Y. and Shiomi,  Turbomachinery, compressible fluid flow, effective utilization of fluid energy
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nical and Thermo-Fluid I Fluid I Material an	LElectrical Energy Engineering Course  uid Energy Engineering  mal Engineering
nical and Thermo-Fluid I Fluid I Material an	### Electrical Energy Engineering Course    Linear Engineering
nical and Thermo-Fluid I Fluid I Material an	### Electrical Energy Engineering Course  uid Energy Engineering  mal Engineering  Miyara, A., Mitsutake, Y., Kariya, K. and Ishida, K.  Thermodynamics, energy conversion, power plant systems Heat exchanger, condensation, evaporation, absorption  Engineering  Kinoue, Y. and Shiomi, Turbomachinery, compressible fluid flow, effective utilization of fluid energy multiphase flow  Engineering  Matsuo, S., Compressible fluid flow, effective utilization of fluid energy, multiphase flow  and Design Engineering  maics of Materials, Solid and Structures  Tadano, Y., Taketomi, S. and Morita, S.  Strength of materials
nical and Thermo-Fluid I Fluid I Material an	### Electrical Energy Engineering Course  uid Energy Engineering  nal Engineering  Miyara, A., Mitsutake, Y.  Kariya, K. and Ishida, K.  Thermodynamics, energy conversion, power plant systems  Heat exchanger, condensation, evaporation, absorption  Engineering  Kinoue, Y. and Shiomi,  Turbomachinery, compressible fluid flow, effective utilization of fluid energy multiphase flow  Engineering  Matsuo, S.  Compressible fluid flow, effective utilization of fluid energy, multiphase flow  and Design Engineering  anics of Materials, Solid and Structures  Tadano, Y., Taketomi, S. and Morita, S.  Strength of materials  Advanced solid mechanics
nical and Thermo-Fluid I Fluid I Material an	### Electrical Energy Engineering Course  uid Energy Engineering  mal Engineering  Miyara, A., Mitsutake, Y., Kariya, K. and Ishida, K.  Thermodynamics, energy conversion, power plant systems Heat exchanger, condensation, evaporation, absorption  Engineering  Kinoue, Y. and Shiomi, Turbomachinery, compressible fluid flow, effective utilization of fluid energy multiphase flow  Engineering  Matsuo, S., Compressible fluid flow, effective utilization of fluid energy, multiphase flow  and Design Engineering  maics of Materials, Solid and Structures  Tadano, Y., Taketomi, S. and Morita, S.  Strength of materials

Design and Production Engineering
and Ohshima, F.
Design of machinery and machine elements Tribology of machine elements Surface engineering
Control Engineering
Ocean Energy Engineering
Ocean EngineeringImai, Y. and Murakami, T
Wave energy conversion system, Marine hydrodynamics, Floating system
Thermal Engineering Arima, H. Boiling heat transfer, two-phase flow, effective utilization of thermal energy
Thermal Energy Conversion Systems
Offshore Wind Energy Systems
Electronics, Information and Communication
Advanced Microwave EngineeringToyoda, I., Tanaka, Takayuki. and Nishiyama, Microwave circuits Planar antennas Wireless power transfer, Wireless communication systems
Advanced Computational EngineeringItoh, H and Fukumoto, H.  Artificial general intelligence  Adaptive robots
Educational support system
Human interface
Advanced Optoelectronics
Bionic and Cybernetic Engineering
Photovoltaic System
Parameter estimation of photovoltaic models
Diagnosis of large-scale photovoltaic power plant

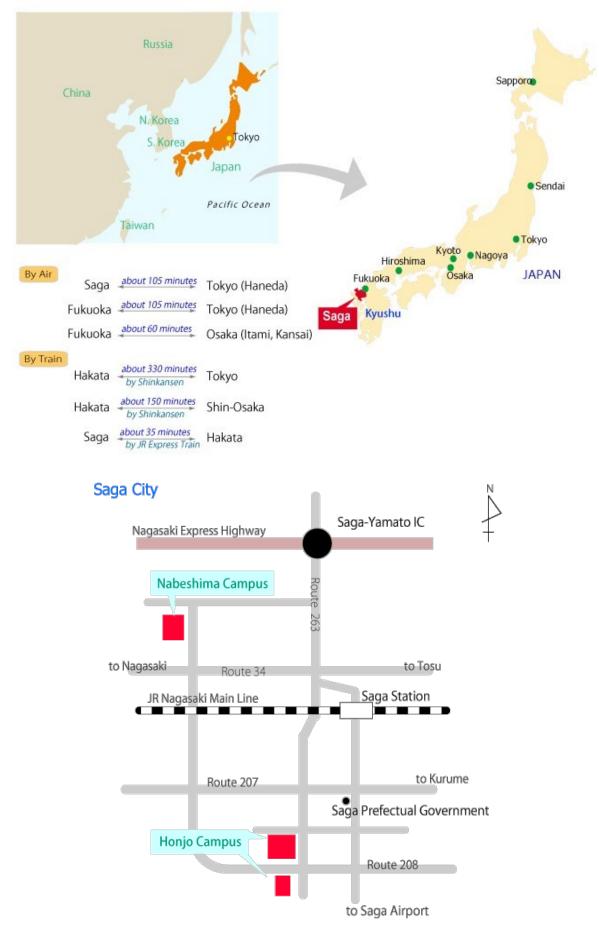
## **Advanced Power Electronics** Power Semiconductor Device Fabrication and Measurements Diamond and Gallium Oxide Semiconductors Epitaxial Growth and Characterization Microwave Electronic Devices and Circuits......Oishi, T. High power and high frequency electronic devices using wide bandgap semiconductors Device modeling technology Plasma Energy Engineering...... Ohtsu, Y. and Ihara, S. Plasma processing Thin film preparation Dry etching process High voltage engineering Pulsed power engineering Plasma engineering Synchrotron light application Electron spectroscopy Nano-scale materials Biological and Material Engineering Course **Biomedical Engineering** Medical systems control. Plant systems control. Remote systems control. Mechatronic systems control and robotics. Reliability analysis for power plant. Control systems design. Bioimaging and Sensing...... Kimoto, A. and Yamaoka, Y. Biosensors; Intelligent-composite multisensors Biosensors; Tactile sensors mimicking human perceptions Biosensors; Non-invasive imaging with composite sensors Biomedical imaging; Photoacoustic imaging Biomedical imaging; Nonlinear optics Numerical analysis of electromagnetic field Optimal design of electromagnetic apparatus Modelling of magnetic materials Soft computing

Compressible fluid flow, effective utilization of fluid energy, multiphase flow

Self-organizing maps

Sensing SystemsTera	moto, K.
Non-destructive testing.	
Inverse problems in multidimensional sensing.	
Wave-field analysis	
Biomedical sensing by ultrasound	
Photonic Sensing.	
Nano-scale Sensing.	
Signal processing	
Biomedical Sensing	. I. Khan
Sensing systems of biomedical engineering dynamics	
Robotics and Computational Intelligence	Izumi, K
Robotics, Mechatronics, Computational Intelligence, Machine learning	5

## Access to Honjo Campus, Saga University



# EDUCATION PROGRAM FOR AI AND DATA SCIENCE SPECIALISTS (EPAD)

## GRADUATE SCHOOL OF SCIENCE AND ENGINEERING, SAGA UNIVERSITY

## APPLICATION FORM

### INSTRUCTIONS (記入上の注意)

- 1. Application should be typewritten or written in Roman block capitals. (記入は楷書又は大文字のローマ字体を用いること。)
- 2. Numbers should be written in Arabic figures. (数字は算用数字を用いること。)
- 3. Year should be written in the Anno Domini system. (年号はすべて西暦とすること。)
- 4. Proper nouns should be written in full and not be abbreviated. (固有名詞はすべて正式な名称とし、一切省略しないこと。)
- 5. An Examination fee of 30,000 Yen should be enclosed. (検定料 30,000 円を添えること。)
- 6. Write your name and the address within the box below for notifying the result of the selection. This box will be used for the addressing stickers. (合格通知書等を送付するので氏名と住所を下記欄に記入のこと。この欄は住所ラベルとして使用する。)

Name	:		
Present address	:		
Tel/Fax	:		

*受験番号	
第	号

# EDUCATION PROGRAM FOR AI AND DATA SCIENCE SPECIALISTS (EPAD) GRADUATE SCHOOL OF SCIENCE AND ENGINEERING, SAGA UNIVERSITY (DOCTOR COURSE)

佐賀大学大学院理工学研究科 AI・データサイエンス高度人材育成プログラム (博士後期課程)入学志願票

Co	urse					Paste a passport sized
	☐ Mathematical and Information Science					photograph or digital
	Mechanical and Electrical	image taken within the				
	Biological and Material En		past 6 months. Write your name and nationality in			
Pei	riod of Hope for Admission	: □Octobei	r, 2022 🗆 Ar	oril, 2023		block letters on the back of the photo.
Na -	me of the desired supervise	or(指導を希望	する主指導教員	名をかならず記	三入すること。)	(4.5 cm×3.5 cm photo) (写真 (4.5 cm×3.5cm) )
1.	Name in full, in native la	inguage (姓	名(自国語))			
_	(Family name)  In Roman block capitals (	, (First	name)	, (Mi	ddle name)	(Sex) □Male (男) □Female (女)
-	(Family name)	, (First	name)	, (Mi	ddle name)	(Marital Status)
2.	Nationality (国籍)					□Single (未婚) □Married (既婚)
3.	Date of birth (生年月日) _	Year 19 (年)	,Month	,Date	,Age (年齢)	(As of April 1, 2022)
4.	Present status; with the (現職(在学大学名又は勤務先名まで	name of the	university			oyer
5.	Present address and tele (現住所及び電話, ファックス番号 Present address (現住所):			e number o	r E-mail add	ress
	電話番号/FAX 番号(Telephon	e/facsimile	number):			
	E-mail address :		_			
6. 7.	Permanent address (本籍 Field of specialization stu (過去に専攻した専門分野(できるだ	idied in the	_	detailed an	nd specific as	possible.)

## 8. Educational background (学歴)

	Name and Address of School (学校名及び所在地)	Year and Month of Entrance and Completion (入学及び卒業年 月)	Amount of time spent at the school attended (修学年数)	Diploma or Degree awarded,Major subject (学位・資格,専攻科目) When taking leave of absence,the period and reason. (休学した場合はその期間・理 由)
Elementary Education (初等教育)	Name (学校名)	From (入学)	years (年)	
Elementary School (小学校)	Location (所在地)	To (卒業)	and months (月)	
Secondary Education (中等教育)	Name (学校名)	From (入学)	years (年)	
Lower Secondary School (中学)	Location (所在地)	To (卒業)	and months (月)	
Upper Secondary School (高校)	Name (学校名) Location (所在地)	From (入学) To (卒業)	years (年) and months (月)	
Higher Education (高等教育)	Name (学校名)	From (入学)	years (年)	
Undergraduate Level (大学)	Location (所在地)	To (卒業)	and months (月)	
Graduate Level (大学院)	Name (学校名) Location (所在地)	From (入学) To (卒業)	years (年) and months (月)	
(以上を通算した全	ling mentioned above 学校教育修学年数) ril 1, 2022 月 1 日現在)	years(年)		

- \* If the blank spaces above are not sufficient for the information required, please attach a separate sheet ((注)上欄に書ききれない場合には、適当な別紙に記入して添付すること。)
- 9. State the titles or subjects of books or papers (including graduation thesis authored by the applicant), if any, with the name and address of publisher and the date of publication. (著書, 論文(卒業論文を含む。)があればその題名, 出版社名, 出版年月日, 出版場所を記すこと。)

0. Employment Record: Begin with the most recent employment, if applicable. (職性)					
Name and address of organization	Period of employment	Position	Type of work		
(勤務先及び所在地)	(勤務期間)	(役職名)	(職務内容)		

wame and address of organization (勤務先及び所在地)	(勤務期間)	Position (役職名)	Type of work (職務内容)
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1)	Name and address of institution (字智機関及びその任所)

ii)	Period of study:	from	to			,	
	(学習期間)		Year (年) Month (月)		Year (年)Month (月)		Years(年間)

iii) Name of teacher (教師名)

iv) Japanese language proficiency: Evaluate your level and insert an X where appropriate in the following blank space. (日本語能力を自己評価のうえ,該当欄に×印を記入すること。)

	Excellent(優)	Good(良)	Fair(可)	Poor(不可)
Reading (読む能力)				
Writing (書く能力)				
Speaking (話す能力)				

12. Foreign language proficiency: Evaluate your level and insert an X where appropriate in the following blank space. (外国語能力を自己評価のうえ,該当欄に×印を記入すること。)

	Excellent(優)	Good(良)	Fair(可)	Poor(不可)
English(英語)				
French(仏語)				
German(独語)				
Spanish(西語)				

## 13. Family background (家族状況)

Name(氏名)	Relationship		Occupation
	(続柄)	(年齢)	(職業)

members to Sag * He/She is advise involved in findicare advised to control been found.  (注) 家族用の宿舎	ga, Japan.) 同伴家族欄(sed to take into considerang living quarters. Therefore alone first and let をみつけることは相当困難で	e following information if yor 佐賀に来る場合,同伴予定の家族 ation various difficulties and the refore, those who wish to be act their dependents come after s あり賃貸料も非常に割高になるので きをみつけた後、家族を呼び寄せるこ	がいる場合に記入す ne great expense th companied by thei suitable accommod あらかじめ承知された	ること。) nat will be ir families lation has
	Name	Relationship	Age	
	(氏 名)	(続柄)	(年 齢)	
15. Person to be noti	fied in applicant's home	country in case of emergency	(緊急の際の母国の連絡を	<b>七)</b>
i) Name in ful	](氏名):			
	ith telephone number, fa スを記入のこと。)	acsimile number, e-mail addres	:s:(住所:電話番号,ファッ	<del></del> クス番号及び
現住所(present ad	ldress):			
電話番号/FAX 番号(	Telephone/facsimile nur	mber):		
E-mail address				
iii) Occupation (	職業):			
iv) Relationship	(本人との関係):			
16. Immigration Rec	ords to Japan. (日本への渡	航記録)		
Date (日付)	Purpose (渡航目的)			
From To				
From To				
	Date of application(申請 Applicant's signature(申 Applicant's name (in R	申請者署名):		

block capitals)(申請者氏名):

*	受験番号	
第		号

## EDUCATION PROGRAM FOR AI AND DATA SCIENCE SPECIALISTS (EPAD) (DOCTOR COURSE)

### ADMISSION TICKET FOR THE EXAMINATION

Graduate School of Science and Engineering, Saga University 佐賀大学大学院理工学研究科 AI・データサイエンス高度人材育成プログラム(博士後期課程) 受験票

		文的人	বৰ				
1. Course (	志望コース)						
☐ Mathematic	cal and Informa	ation Science			Photo		
☐ Mechanical	and Electrical	Energy Engineering			$4.5\mathrm{cm}  imes$	3.5cm	
☐ Biological a	Biological and Material Engineering				Taken w		
Period of Hope	for Admission	$\Box$ October, 2022 $\Box$ A	pril, 2	2023			
2. Sex	Male (男)	□ Female (女)					
3. Name in fu	ıll; in native la	nguage(氏名(自国語)	)				
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	納 付 EXAMINAT	, .			収証 RECEIPT	書	
※第 号	受験者氏名 (Applicant's Name)			¥3	80,000		
	研究科名 (Graduate Course)	理工学研究科		日本円に (JAPANE	限る ESE CURR	ENCY)	
2022 年度	専攻名 (Department)	理工学専攻			入学検定料 NATION FI	EE)	
¥ 30,0	000 日本円	日に限る		※西暦	年	月	日
	(JAF	PANESE CURRENCY)		受験者氏。 (Applicar	名 at's Name)		
ただし,入学検定料 (EXAMINATION FEE) ※西暦 年 月 日 領収							様
				国立大	学法人佐賀	 [大学	

領収証書及び納付書の氏名欄は、必ず明記すること。 ※印の欄は、記入しないこと。

(Applicant should not fill in except his/her name, Graduate Course and Department.)

## 推 薦 書 LETTER OF RECOMMENDATION

佐賀大学長 様

To: President of Saga University

	被推薦者 Recommendee 氏名 Full Name: 生年月日 Date of Birth: 国籍 Nationality:	
	日付 Date: (month) (date) (year)	
推薦者 Recommender 署名 Signature: 氏名 Print Name:		
役職 Title and Institution (or Company):		
現住所 Present Address:		
Eメールアドレス E-mail Address:		

\* 受験番号 第 号

## 証 明 書 LETTER OF REFERENCE

## 佐賀大学長 様

To: President of Saga University

	被証明者 Referenced person 氏名 Full Name: 生年月日 Date of Birth:	
	国籍 Nationality:	
	日付 Date:(month) (date) (year)	
証明者 Reference person 署名 Signature: 氏名 Print Name:		
役職 Title and Institution (or Company):		
現住所 Present Address: ——		
E メールアドレス E-mail Address:		